$\dot{\imath}^{3}$ DX Intelligent Control Station

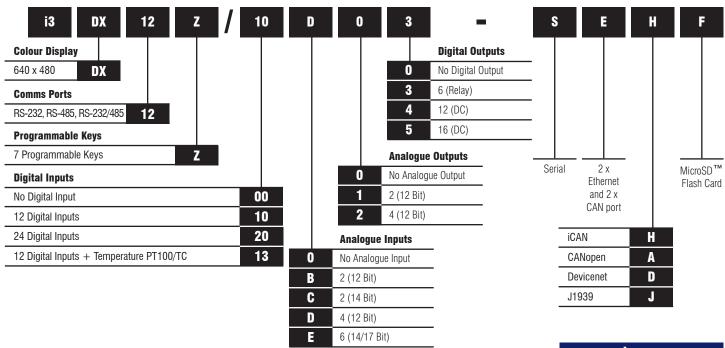
- 10.4" TFT Colour Touchscreen
- 65,535 Colours, VGA (640 x 480)
- MicroSD[™] Data storage upto 32GB
- Real Time Clock
- 2 CAN Port, 3 RS-232 / RS-485
- 2 Integral Ethernet Ports
- USB Port for Programming
- USB Port for Flash Drives upto 2TB
- Addressable function keys
- 1MB RAM (Program), 27MB (Graphical)
- IP65 (NEMA4)
- 10 30 VDC Power Supply
- Online Programming
- Free Configuration Software
- Remote I/O Communication
- Optional Modem (SMS, GSM, GPRS)



Options & Ordering Codes

Standard Options	DI	DO	AI	AO
i3DX12Z/10D03-SEHF	12	6 Relay	4	-
i3DX12Z/13C14-SEHF	12	12	2*	2
i3DX12C/20B05-SEHF	24	16	2	-
i3DX12Z/10B04-SEHF	12	12	2	-
i3DX12Z/10E24-SEHF	12	12	6*	4
i3DX12Z/00000-SEHF	-	-	-	-

* Universal Analogue Inputs





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Technical Specifications

General Specifications	
Required Power (Steady State)	650mA @ 24VDC
Required Power (Inrush)	25A for <1ms @ 24VDC DC Switched
Primary Voltage Range	10-30VDC
Relative Humidity	5 to 95% Non-Condensing
Clock Accuracy	+/-20ppm Maximum at 25°C (+/-1 Minute per month)
Operating Temperature	-10°C to +60°C
Storage Temperature	-40° C to $+60^{\circ}$ C
Weight	1.82kg (without I/O)
Approvals	cUL, UL, CE

Display Specifications	
Display Type	10.4" VGA TFT
Resolution	640 x 480
Colour	16-bit (65,536)
Screen Memory	27MB
User-Programmable Screens	1023
Backlight	LED - 50,000 hour life
Screen Update Rate	User configurable within the scan time (perceived as instantaneous in many cases)

Control & Logic Specifications	
Control Language Support	Advanced Ladder Logic Full IEC 61131-3
Logic Program Size & Logic Scan Rate	1MB Maximum 0.013ms/k
Online Programming Changes	Supported in Advanced Ladder
	Digital Inputs - 2048
1/0 Support	Digital Outputs - 2048
I/O Support	Analogue Inputs - 512
	Analogue Outputs - 512
General Purpose Registers	50,000 (words) Retentive 16,384 (bits) Retentive 16,384 (bits) Non-retentive

Connectivity	
Serial Ports	1 RS-232 & 1 RS-485 on first modular jack (MJ1/2) 1 RS-232 or 1 RS-485 on second modular jack (MJ3)
USB mini-B	USB 2.0 (480MHz) Programming & Data Access
USB A	USB 2.0 (480MHz) for USB FLASH Drives (up to 2TB)
CAN	Remote I/O, Peer-to-Peer Comms, i3 Configurator
Ethernet	10/100MB (Auto-MDX), Modbus TCP, HTTP, FTP, SMTP, i3 Configurator, Ethernet IP
Remote I/O	IOS, Smart I/O, iSmart
Removable Memory	MicroSD™ (support for 32GB max) Application updates, Datalogging, more

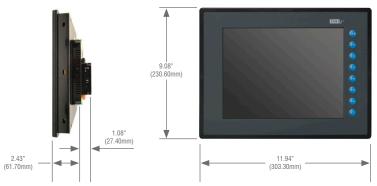
Input / Outp	out Specifica	tions								
Model	DC In	DC Out	Relays	HS In	HS Out	mA/V In	mA/V RTD/TC	mA/V Out	High Speed	d Counters
10D03	12		6	4		4			Number of Counters	2
10B04	12	12		4	2	2			Maximum Frequency	500kHz each
20B05	24	16		4	2	2			Accumulator Size	32-bits each
13C14	12	12		4	2		2	2	Modes Si	upported
10E24	12	12		4	2		6*	4*	Totalizer	Quadrature
	0 1				0 1			tputs. Model High-speed		Frequency Measurement

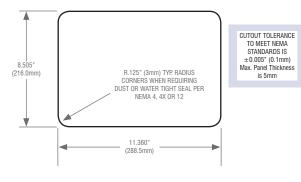
outputs can be used for PWM and Pulse Train Outputs, currently limited to <65kHz. Model 10E14 features a 14/17 bit analogue I/O.

2 Position Controlled Outputs 1 ON/OFF Setpoint per Output

*Up to six mA/V In, RTD/TC, and mA/V Out

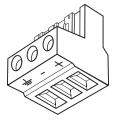
Dimensions & Panel Cutout





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Ports & Connectors



DC Input / Frame

Torque rating: 4.5-7 Lb-in (0.50-0.78Nm) DC- is internally connected to I/O V-, but is isolated from CAN V-

A Class 2 power supply must be used

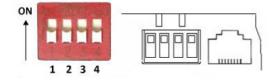
Primary Power Port Pins					
Pin	Signal Signal Description				
1	Ground	Frame Ground			
2	DC-	Input Power Supply Ground			
3	DC+	Input Power Supply Voltage			



MJ1/2 Independent Serial Ports

MJ1: RS-232 with Full Handshaking MJ2: RS-485 Half-Duplex

PIN	MJ1	PINS	MJ2	PINS
	Signal	Direction	Signal	Direction
8	TXD	OUT	-	-
7	RXD	IN	-	-
6	0 V	Ground	0 V	Ground
5	+5V@60mA	OUT	+5V@60mA	OUT
4	RTS	OUT	-	-
3	CTS	IN	-	-
2	-	-	RX- / TX-	IN / OUT
1	-	-	RX+/TX+	IN / OUT



Switch	Name	Function	Default
1	MJ3 RS-485 Termination	ON = Terminated	OFF
2	M12 Duploy	ON = Half	OFF
3	MJ3 Duplex	OFF = Full	UFF
4	MJ2 RS-485 Termination	ON = Terminated	OFF

Fixed	Digital/Analog			i3DX Model		
Address	Address I/O Function	10D03	10B04	20B05	13C14	10E24
	Digital Inputs	1-12	1-12	1-24	1-12	1-12
%I1	Reserved	13-32	13-31	25-31	13-31	13-31
	ESCP Alarm	n/a	32	32	32	32
%Q1	Digital Outputs	1-6	1-12	1-16	1-12	1-12
70 QL I	Reserved	7-24	13-24	17-24	13-24	13-24
0/ 414	Analogue Inputs	1-4	1-2	1-2	1-2	1-4:33-38
%AI1	Reserved	5-12	3-12	3-12	3-12	n/a
%AQ1	Reserved	n/a	1-8	1-8	1-8	1-12
%AQ1	Analogue Outputs	n/a	n/a	n/a	9-10	n/a

Reserved areas maintain backward compatability with other i3 Controller models





Locking Spring-Clamp 2-Terminators Per Conductor Mounting screw torgue rating: 4.5 Lb-in (0.50Nm)

SHLD and V+ pins are not internally connected to i³DX

	Primary Power Port Pins					
Pin	Signal Description		Direction			
1	V-	CAN Ground - Black	-			
2	CN L	CAN Data Low - Blue	IN / OUT			
3	SHLD	Shield Ground - None	-			
4	CN H	CAN Data High - White	IN / OUT			
5	V+ (NC)	No Connect - Red	-			



MJ3 Serial Port

Two multiplexed serial ports on one modular jack (8posn)

Signal	Divestien
	Direction
TXD RS-232	OUT
RXD RS-232	IN
0 V	Ground
+5V@60mA	OUT
TX- RS-485	OUT
TX+ RS-485	OUT
RX- RS-485	IN
RX+ RS-485	IN
	RXD RS-232 0 V +5V@60mA TX- RS-485 TX+ RS-485 RX- RS-485 RX- RS-485

Built-in I/O

I/O is mapped into i3 Register space, in three separate areas -Digital/Analogue I/O, High-Speed Counter I/O, and High-Speed Output I/O. Digital/Analogue I/O location is fixed starting at 1, but the High-Speed Counter and High-Speed Output references may be mapped to any open register location. For more details on using the High-Speed Counter and High-Speed Outputs, see the i3DX User's Manual.

Default Address*	High Speed Counter Function	i3DX Models		Default Address*	High Speed Output Function	i3DX Models
%I1601	Status Bits	1-8		%I1617	Status Bits	1-8
&Q1601	Command Bits	1-32		&Q**	Command Bits	1-32
%AI0401	Accumulator 1&2	1-8		n/a	n/a	n/a
%AQ0401	Preload &	1-12	•	%AQ0421	PWM or Pulse Train Parameters	1-20
*Starting Address locations for			•		Starting Address loca %AQ may be re-map	

%I. %Q. %AI & %AQ may be re-mapped by user

**Q1-Q2 are part of the Fixed I/O Map. In High Speed Output mode they can be used to initiate a Stepper/PTO Move





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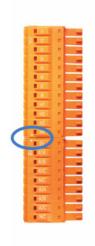
IMO

10E24 I/O Board Specifications

Di	gital DC Inputs	Digital [DC Outputs	
Inputs per Module	12	Outputs per Module	12	
Commons per Module	1	Commons per Module	1	
Input Voltage Range	10-30 VDC	Output Type	Sourcing / 10 K Pull-Down	
Absolute Max. Voltage	35 VDC Max	Absolute Max. Voltage	30 VDC Max	
Input Impedance	10 kΩ	Output Protection	Short Circuit & Overvoltage	
Input Current	Positive Logic Negative Logic	Max. Output Current per Point	0.5A	
Upper Threshold	0.8mA -1.6mA	Max. Total Current per driver	2 A Continuous	
Lower Threshold	0.3mA -2.1mA	Max. Output Supply Voltage	30 VDC	
Min. "On" Input	8 VDC	Min. Output Supply Voltage	10 VDC	
Max. "Off" Input	3 VDC	Max. Voltage Drop at Related Current	0.25 VDC	
Galvanic Isolation	None	I/O Indication	None	
OFF to ON Response	1 ms	Galvanic Isolation	None	
ON to OFF Response	1 ms	Min. Load	None	
Logic Polarity	Positive and Negative based on Common pin level.	OFF to ON Response	150 ns	
I/O Indication	None	ON to OFF Response	150 ns	
High Speed Counter Inputs	4 - DIN 8-12	PWM Out	500kHz	
ligh Speed Counter Max. Freque	ency 500kHz	Output Characteristics	Current Sourcing (Positive Logic)	
Connector Type	3.5mm Pluggable cage clamp connector			
	Analogue Inputs	s, High Resolution		
Number of Channels	6	Absolute Max. Input Voltage	-0.5 to 12V DC	
Input Range	0–20mA, 4-20 mA dc. 0-60mV, 0-10V dc. TC - J, K, N, T, E, R, S, B RTD - PT100, PT1000	Input Impedance (Clamped @ -0.5 to 10.23VDC).	$\begin{array}{l} \mbox{TC / RTD / mV } > 2 \mbox{ M}\Omega \\ \mbox{mA: 15 }\Omega + 1.5 \mbox{ V} \\ \mbox{V: 1.1 }\mbox{M}\Omega \end{array}$	
Nominal Resolution	14 - 17 Bits (variable depending on input type)	Galvanic Isolation	None	
Sensor Range and Accuracy	Input Type	Range	Accuracy	
	TC J	-120 to 1000°C / -184 to 1832°F	\pm 0.2% FS \pm 1°C	
	TC K	-130 to 1372°C / -202 to 2501.6°F	± 0.2% FS ± 1°C	
	TC T	-130 to 400°C / -202 to 752°F	\pm 0.2% FS \pm 1°C	
	TC E	-130 to 780°C / -202 to 1436°F	± 0.2% FS ± 1°C	
	TC N	-130 to 1300°C / -202 to 2372°F	\pm 0.2% FS \pm 1°C	
	TC R, S	20 to 1768°C / 68 to 3214.4°F	\pm 0.2% FS \pm 3°C	
	TC B	100 to 1820°C / 212 to 3308°F	\pm 0.2% FS \pm 3°C	
	PT100/1000	-200 to 850°C / -328 to 1562°F	± 0.15% FS	
	0-20mA	0-20mA	± 0.15% FS	
	0-60mV	0-60mV	± 0.15% FS	
	0-10V	0-10V	± 0.15% FS	
Conversion Speed	Minimum all channels cor			
	Analogu	ie Outputs		
Number of Channels	4	Minimum Current Load	500Ω	
Output Ranges	0-10VDC, 0-20mA, 4-20mA	Galvanic Isolation	None	
Nomimnal Resolution	12 Bits	Conversion Speed	Min. all channels once per scan	
Response Time	One update per ladder scan	· · · · · · · · · · · · · · · · · · ·		
Max. Error at 25°C (excluding zero)	0-20mA 0.1% of FS 0-10V 0.1% of FS	Additional Error for temperatures other than 25°C	20mA 0.0126%/°C	

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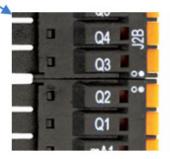






For ease of operability, the high density terminals are divided into more manageable pairs of connectors (J1A + J1B, J2A + J2B, J3A + J3B)

To ensure proper installation, connector symbols must match as seen below:



-	-												•		
2	1	8	8	N	W	W	2	1	ą	8	2	8	2	8	2
1	34						C	- 8	6						

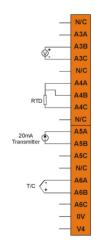
11

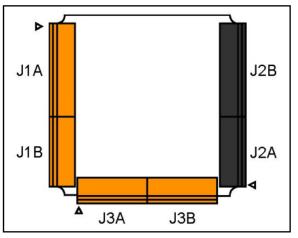
J1 (Ora	ange/Green)	Signal Name	_ ~~
\square	1	V IN1	
	12	V IN2	
	13	V IN3	
	14	V IN4	12-24VDC
	15	V IN5	2 T T 25
<	16	V IN6	
J1A	17	V IN7	Ľ
	18	V IN8	L
	H1	HSC1 / V IN9	
	H2	HSC2 / V IN10	
	H3	HSC3 / V IN11	L
	H4	HSC4 / V IN12	
	0V	Common	
	A1A	Univ. Al 1 pin 1	20mA Transmitter
	A1B	Univ. Al 1 pin 2	
~	A1C	Univ. Al 1 pin 3	
J1B	NC	No Connect	_
	A2A	Univ. Al 2 pin 1	т/с 🤇
	A2B	Univ. Al 2 pin 2	
	A2C	Univ. Al 2 pin 3	
	NC	No Connect	

		12
		13
8		- 14
12-24VDC	5	15
12		16
		17
		18
		H1
		H2
		H3
		H4
		0V
20	mA a	A1A
Tran	smitter $\Phi_{$	A1B
		A1C
		N/C
	T/C	A2A
	1/0 \+	A2B
		A2C
	_	N/C

J2 (B	lack/Green)	Signal Name	V3
	V3	V OUT 3*	V2
-	V2	V OUT 2*	V1
	V1	V OUT 1*	mA4
_	mA4	mA Out 4*	mA3
J2A	mA3	mA Out 3*	mA2
-	mA2	mA Out 2*	mA1
	mA1	mA Out 1*	Q1
	Q1	0UT 1 / PWM1	Q2
	Q2	OUT 2 / PWM2	Q3 1000
	Q3	OUT 3	
	Q4	OUT 4	
	Q5	OUT 5	Q5
	Q6	OUT 6	Q6
	Q7	OUT 7	Q7 LOID
J2B	Q8	OUT 8	Q8 1010
5	Q9	OUT 9	Q9 LOLD
	Q10	OUT 10	Q10
	Q11	OUT 11	Q11
	Q12	OUT 12	Q12
	V+	V External+	V+
	0V	Common	0V

Univ. Al	NC A3A	No Connect Univ. Al 3 pin 1			
Univ. Al		Univ Al 3 pin 1			
Univ. Al	A 2 D				
Univ. AI	A3B	Univ. Al 3 pin 2			
Univ.	A3C	Univ. Al 3 pin 3			
	NC	No Connect			
F	A4A	Univ. Al 4 pin 1			
	A4B	Univ. Al 4 pin 2			
	A4C	Univ. Al 4 pin 3			
	NC	No Connect			
	A5A	Univ. Al 5 pin 1			
	A5B	Univ. Al 5 pin 2			
	A5C	Univ. Al 5 pin 3			
A L	NC	No Connect			
Univ. Al	A6A	Univ. Al 6 pin 1			
5	A6B	Univ. Al 6 pin 2			
	A6C	Univ. Al 6 pin 3			
	NC	No Connect			
	1.1.4	V 0UT 4*			
	V4	V OUT4*			



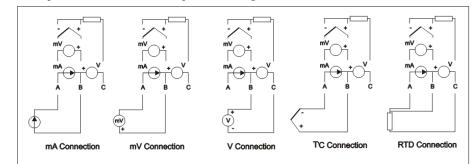


Note * Both mA & V outputs are active for each output channel, however, only the configured output type is calibrated (maximum 4 channels simultaneously).

i^{3} DX Intelligent Control Station



Example of Universal Input Wiring Schematic



Configuration

The data registers as follows:-

Digital Inputs	Digital Outputs	Analogue Inputs	Analogue Outputs
%I1-12	%Q1-12	%AI1-4, %AI33-38	%AQ9-12

Note: The first four Analogue inputs are mapped to both %Al1-4 and %Al33-36, analogue input channels 5 & 6 are mapped to %Al37 and %Al38 respectively only.

Data Values

The analogue inputs return data types as follows:-

Input Mode	Data Format	Comment
0-20mA, 4-20mA	0-32000	
0-10V, 0-60mV	0-32000	
TC, RTD	Temperature in °C or °F to 1 decimal place xxx.y	°C or °F may be selected in the I/O config section. The value is an integer, the user should divide by 10.

Status Register

Register	Descriptions										
%R1	Bit-wise status re	gister enable – R1.1	– R1.9 enable for reg	isters R2 to R9							
%R2	Firmware version										
%R3	Watchdog count -	 cleared on power-u 	p.								
%R4	Status bits -				164	3	2	1			
					Reserved	Normal	Config	Calibration			
%R5	Scan rate of the 1	Scan rate of the 10E24 board (average) in units of 100μ S.									
%R6	Scan rate of the 10E24 board (max) in units of 100 μ S.										
%R7	Channel Status	Channel 2			Channel 1						
	8	7	6	5	4	3	2	1			
	Open RTD	Out of Limits	Shorted RTD	Open TC	Open RTD	Out of Limits	Shorted RTD	Open TC			
%R8	Channel Status	Channel 4			Channel 3						
	8	7	6	5	4	3	2	1			
	Open RTD	Out of Limits	Shorted RTD	Open TC	Open RTD	Out of Limits	Shorted RTD	Open TC			
%R9	Channel Status	Channel 6			Channel 5						
	8	7	6	5	4	3	2	1			
	Open RTD	Out of Limits	Shorted RTD	Open TC	Open RTD	Out of Limits	Shorted RTD	Open TC			
%R10-14	Reserved										

Note: For the purposes of the example, the block is shown starting at %R1, but it can be set to anywhere in the %R memory map.

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Safety

WARNING: Battery may explode if mistreated. Do not recharge, disassemble or dispose of in fire.

WARNING: EXPLOSION HAZARD - BATTERIES MUST ONLY BE CHANGED IN AN AREA KNOWN TO BE NON-HAZARDOUS

This equipment is suitable for use in Class 1, Division 2, Groups A, B, C and D or Non-hazardous locations only.

FOR U.S. & CANADA ONLY

Power input and output (I/O) wiring must be in accordance with Class 1, Division 2 wiring methods of the National Electric Code, NFPA70 for installations in the U.S. or as specified in Section 18-1J2 of the Canadian Electric Code for installations within Canada and in accordance with the authority having jurisdiction.

WARNING: EXPLOSION HAZARD - Do not disconnect equipment unless power has been switched off or the area is known to be non-hazardous.

WARNING: EXPLOSION HAZARD - Substitution of components may impair suitability for Class 1, Division 2.

Digital outputs shall be supplied from the same source as the i3 Controller.

WARNING: Only qualified electrical personnel familiar with the construction and operation of this equipment and the hazards involved should install, adjust, operate, or service this equipment. Read and understand this manual and other applicable manuals in their entirety before proceeding. Failure to observe this precaution could result in severe bodily injury or loss of life.

WARNING: To avoid the risk of electric shock or burns, always connects the earth ground before making any other connections.

WARNING: To reduce the risk of fire, electrical shock, or physical injury it is strongly recommended to fuse all Power Sources connected to the i3 controller. Be sure to locate fuses as close to the source as possible.

WARNING: Replace fuse with the same type and rating to provide protection against risk of fire and shock hazards.

WARNING: In the event of repeated failure, do not replace the fuse again as a repeated failure indicates a defective condition that will not clear by replacing the fuse.

Jumpers on connector JP1 and others shall not be removed or replaced while the circuit is live unless the area is known to be free of ignitable concentrations of flammable gases or vapours.

Common Cause of Analogue Input Tranzorb Failure

If a 4-20mA circuit is initially wired with loop power, but without a load, the analogue Input could see 24VDC. This is higher than the rating of the tranzorb. This can be solved by NOT connecting loop power prior to load connection, or by installing a low-cost PTC in series between the load and analogue input.

